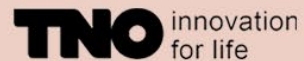


BCworkshop2024



12th workshop on

Back contact solar cell
and module technology

#BCworkshop

December 4-5, 2024
Delft, the Netherlands

Hosted by  TU Delft

Thanks to our sponsors for their support



Highlights first day

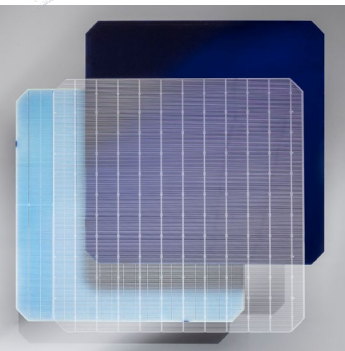
BC Workshop 2024



BC Workshop 2024 - Day 1 Agenda - A few highlights

09:00 - 09:20	Conference opening
09:20 - 10:40	S1: Back contact cells & modules in R&D
10:40 - 11:20	Coffee break
11:20 - 12:40	S2: Back contact cells in industry
12:40 - 13:20	Lunch
13:20 - 14:00	Visiting the Green Village
14:00 - 15:20	S3: Materials and tools for BC cell technology
15:20 - 15:50	Coffee break
15:50 - 17:30	S4: Characterization / Outdoor testing / Shading resilience
17:30 - 17:40	End of the first day, reaching X Center @ TU Delft
18:00 - 21:00	Social dinner

S1: Back contact cells & modules in R&D



$$\eta_{\text{POLO IBC}} = iV_{\text{oc}} \times iFF \times J_{\text{sc}} = 26.7\%$$

$$\eta_{\text{POLO IBC}} = 23.9\% (1.0 \Omega\text{cm} < r_{\text{Ga}} < 2.0 \Omega\text{cm})$$

$$\eta_{\text{POLO IBC-target}} = 25\% (\text{optimized Ag/Al})$$

$$J_{0,p\text{-poly}} = 2.3 \text{ fA/cm}^2 (\text{in-situ doped LPCVD})$$

Two different industrial POLO² IBC designs

From 2026, POLO² IBC cells on M10 wafers

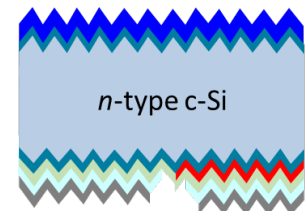
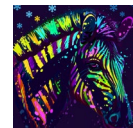
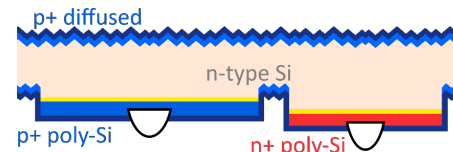
$$\eta_{\text{polyZEBRA}} = 24.12\%$$

Potential $\eta_{\text{polyZEBRA}} > 25\%$

Transfer results from test structures to cell

Production cost of Cu-polyZEBRA module close to TOPCon

Investigating PVD fabrication route of TBC cells

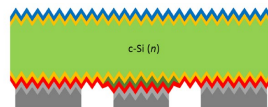
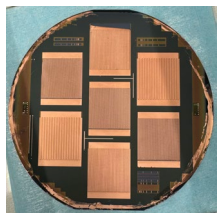


TMO-based IBC SHJ cell

Unveiled transport mechanisms across novel ETL stack

$$\eta = 23.10\% (\text{with Cu-plated contacts})$$

$$\eta_{\text{target}} > 24\% \text{ in the short term}$$



■ a-SiH (i) ■ a-SiH (n) ■ a-SiH (p) ■ SiN_x ■ TCO ■ Ag

$$\eta = 24.7\% (\text{mini-module})$$

Several times surviving IEC tests

Excellent platform for 3TT devices with $\eta = 29.56\%$ (24.5 cm²)



S2: Back contact cells in industry



Currently prototyping Maxeon 7 process with self-aligned micro-trench structure.

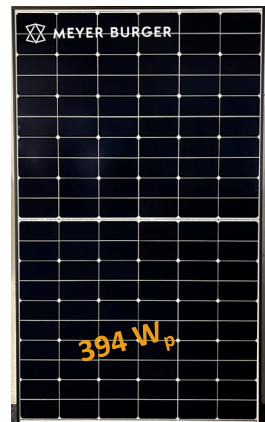
Efficiency loss analysis done for Maxeon 7 and projected for Maxeon 8 (minimal J_0).

$\eta_{\text{Maxeon 8}} > 26\%$ (anticipated, with Al metallization)

Largest remaining loss: poor infrared absorption

Several blocks for TBC cell mass production:

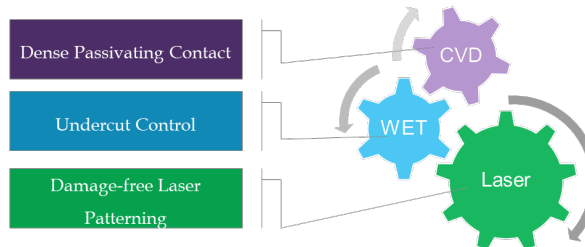
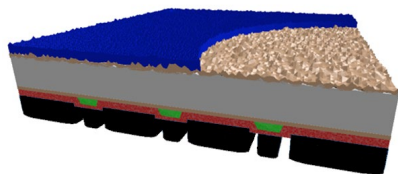
1. Bifacial limit, at most 75% in HTBC
2. TOPCon in-line upgrade rapidly ($\Delta\eta_{2025} = +0.4\%_{\text{abs}}$)
3. $\Delta\eta$ negative in case half cut wafers
4. Simplified TBC structure with boron diffusion junction but not easy in experiment trial
5. Expensive laser and low yield,
6. Thermal cycle induced delamination,
7. Ag consumption in solder joint.



$\eta > 25\%$

10 process steps (In-free, 3.3 mg/ W_p)

IEC superior reliability

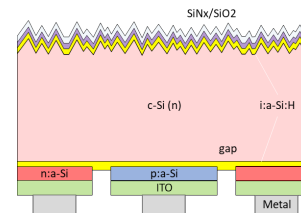


Dense Passivating Contact

Undercut Control

Damage-free Laser Patterning

$\eta_{\text{record}} > 27.3\%$



CVD: dense a-Si:H layers ($T_{\text{depo}} = 240\text{ }^\circ\text{C}$)

WET: controlling SiNx undercut with KOH + SDBS

LASER: smart combination of sacrificial layers

S3: Materials and tools for BC cell technology

Take Aways for Today

HIGHLINE

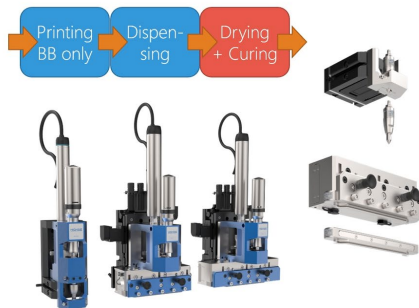
Technology:

- o Reliable Printheads + Nozzle Kits
- o AI controlled Process

Key Applications:

- o Fine Line Dispensing down to <math><20\mu\text{m}</math>
- o Dots and Intermittent Coating

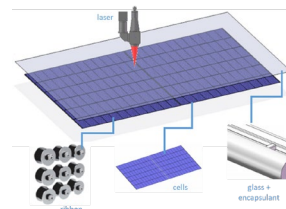
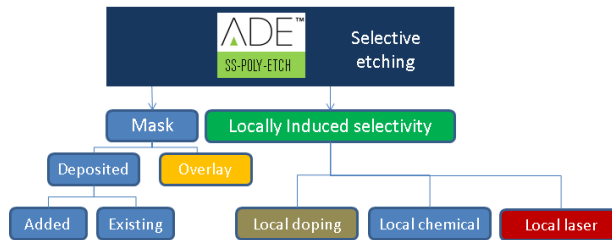
Strong Partnerships for integration in Cell and Module!



High selectivity of ADE single-side gas-phase etch



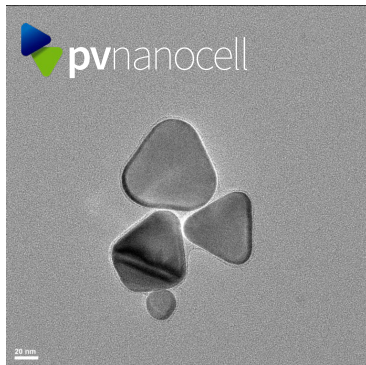
Enables several paths and options for patterning poly-silicon layers



Laser Integrated Bonding for module manufacturing

Addressed reliability

$$\Delta\text{TM ratio} > 0.5\% \text{ --- } \Delta P_{\text{mpp}} > 4W_p$$

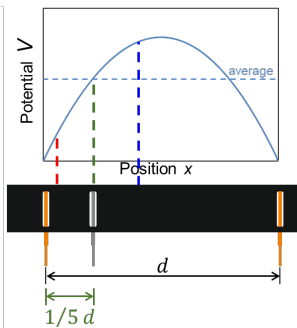
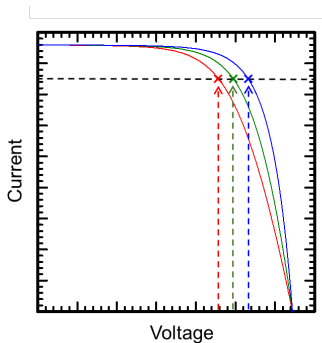


Single-crystal nanoparticles offer superior oxidation resistance

PVN own produces copper nanoparticles (d = 40 nm)

Printing 25-μm wide line with PTP technique

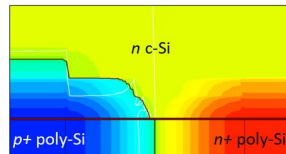
S4: Characterization / Outdoor testing / Shading resilience



Multi-spectrum spectral responsivity using a LED solar simulator



Fakir vs PCB vs Custom chucks



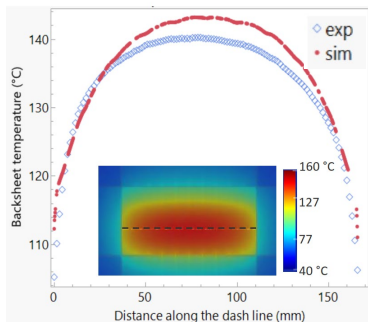
Band-to-band tunneling between BSF and emitter in IBC solar cells



20% energy yield gain with cells with -0.3 V breakdown voltage and partially shaded for 20% of the time



Measured 7.9% increase in specific yield with IBC cells with -3 V breakdown



Ideal uniform breakdown can still show high temperature

High $V_r \rightarrow T_{peak}$ increases with power of the substring

Low $V_r \rightarrow T_{peak}$ depends on reverse IV curve

Challenging modelling

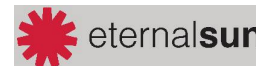


High- η solar cells show capacitive behavior during fast sweeps \rightarrow solar simulators needed with long pulse or steady-state capability

PVK modules are metastable. Sweep times > production cycle times \rightarrow standardized characterization methods mainly based on MPP and inline characterization can be performed using a controlled offset from offline characterization



Double-side method for accurate characterization of both bifacial modules with asymmetric design and bifacial 2T tandem modules







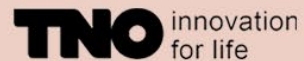
BC Workshop 2024 - Day 2 Agenda

09:00 - 09:20	Highlights first day
09:20 - 10:40	S5: Novel interconnection technologies for BC modules
10:40 - 11:20	Coffee break
11:20 - 12:00	Round table 1: <i>Will BC technology be the next big thing?</i>
12:00 - 12:40	Round table 2: <i>Technology challenges in BC technology?</i>
12:40 - 14:00	Lunch
14:00 - 16:15	S6: Industrial BC modules and field applications
16:15 - 16:30	Closing remarks and announcement next BC workshop

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